

Dual P-channel MOSFET

ELM18803BA-S

■ General description

ELM18803BA-S uses advanced trench technology to provide excellent $R_{ds(on)}$ and low gate charge. Internal ESD protection is included.

■ Features

- $V_{ds} = -12V$
- $I_d = -7A$ ($V_{gs} = -4.5V$)
- $R_{ds(on)} < 18m\Omega$ ($V_{gs} = -4.5V$)
- $R_{ds(on)} < 22m\Omega$ ($V_{gs} = -2.5V$)
- $R_{ds(on)} < 29m\Omega$ ($V_{gs} = -1.8V$)
- ESD Rating : 4000V HBM

■ Maximum absolute ratings

Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	-12	V	
Gate-source voltage	V_{gs}	± 8	V	
Continuous drain current Ta=25°C	I_d	-7	A	1
Ta=70°C		-5.8		
Pulsed drain current	I_{dm}	-20	A	2
Power dissipation Ta=25°C	P_d	1.4	W	1
Ta=70°C		0.9		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■ Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	t≤10s	$R_{\theta ja}$	73	90	°C/W	1
Maximum junction-to-ambient	Steady-state		96	125	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	63	75	°C/W	3

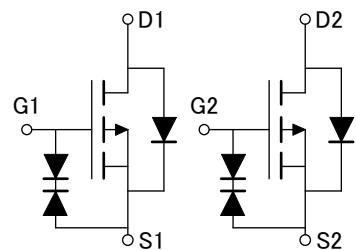
■ Pin configuration

TSSOP-8 (TOP VIEW)



Pin No.	Pin name
1	DRAIN1
2	SOURCE1
3	SOURCE1
4	GATE1
5	GATE2
6	SOURCE2
7	SOURCE2
8	DRAIN2

■ Circuit



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■ Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BVdss	I _d =-250 μA, V _{gs} =0V	-12			V
Zero gate voltage drain current	Idss	V _{ds} =-9.6V V _{gs} =0V			-1 -5	μA
Gate-body leakage current	Igss	V _{ds} =0V, V _{gs} =±4.5V V _{ds} =0V, V _{gs} =±8V			±1 ±10	μA
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , I _d =-250 μA	-0.30	-0.55	-1.00	V
On state drain current	I _{d(on)}	V _{gs} =-4.5V, V _{ds} =-5V	-20			A
Static drain-source on-resistance	R _{d(on)}	V _{gs} =-4.5V I _d =-7A		15	18	mΩ
		T _j =125°C		19	23	
		V _{gs} =-2.5V, I _d =-6A		18	22	mΩ
		V _{gs} =-1.8V, I _d =-5A		22	29	mΩ
		V _{gs} =-1.5V, I _d =-1A		28		mΩ
Forward transconductance	G _f s	V _{ds} =-5V, I _d =-7A		34		S
Diode forward voltage	V _{sd}	I _s =-1A, V _{gs} =0V		-0.78	-1.00	V
Max. body-diode continuous current	I _s				-2.5	A
DYNAMIC PARAMETERS						
Input capacitance	C _{iss}	V _{gs} =0V, V _{ds} =-6V, f=1MHz		3960	4750	pF
Output capacitance	C _{oss}			910		pF
Reverse transfer capacitance	C _{rss}			757		pF
Gate resistance	R _g	V _{gs} =0V, V _{ds} =0V, f=1MHz		6.9	8.5	Ω
SWITCHING PARAMETERS						
Total gate charge	Q _g	V _{gs} =-4.5V, V _{ds} =-6V, I _d =-7A		36.6	44.0	nC
Gate-source charge	Q _{gs}			3.4		nC
Gate-drain charge	Q _{gd}			10.0		nC
Turn-on delay time	t _{d(on)}	V _{gs} =-4.5V, V _{ds} =-6V R _l =0.86 Ω, R _{gen} =3 Ω		15		ns
Turn-on rise time	t _r			43		ns
Turn-off delay time	t _{d(off)}			158		ns
Turn-off fall time	t _f			95		ns
Body diode reverse recovery time	t _{rr}	I _f =-7A, dI/dt=100A/μs		49.0	60.0	ns
Body diode reverse recovery charge	Q _{rr}	I _f =-7A, dI/dt=100A/μs		19.4		nC

NOTE :

1. The value of R_{θja} is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with T_a=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The R_{θja} is the sum of the thermal impedance from junction to lead R_{θjl} and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_a=25°C. The SOA curve provides a single pulse rating.

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■ Typical electrical and thermal characteristics

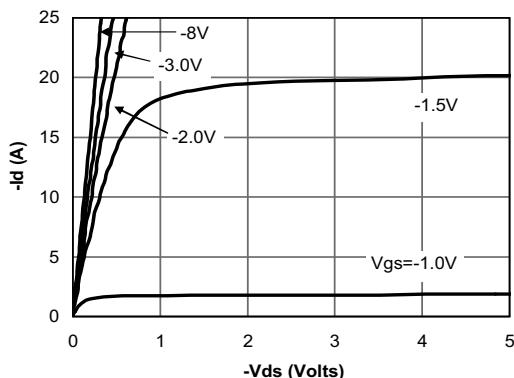


Fig 1: On-Region Characteristics

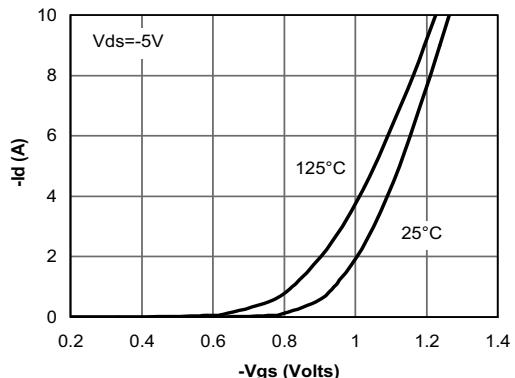


Figure 2: Transfer Characteristics

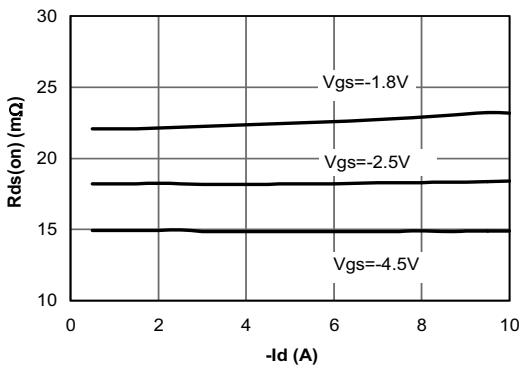


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

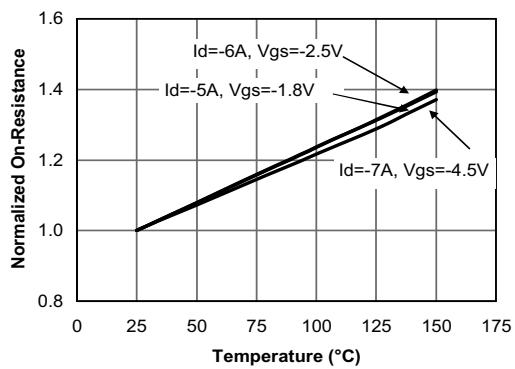


Figure 4: On-Resistance vs. Junction Temperature

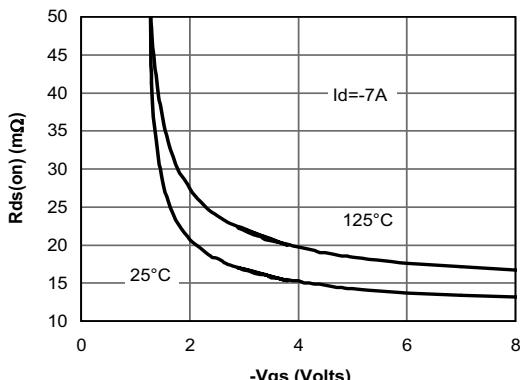


Figure 5: On-Resistance vs. Gate-Source Voltage

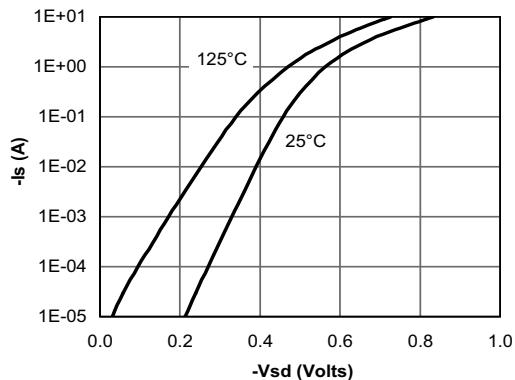


Figure 6: Body-Diode Characteristics

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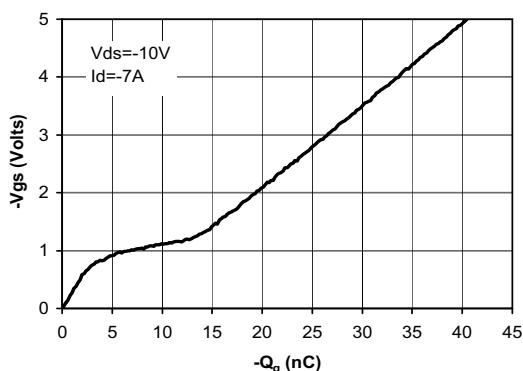


Figure 7: Gate-Charge Characteristics

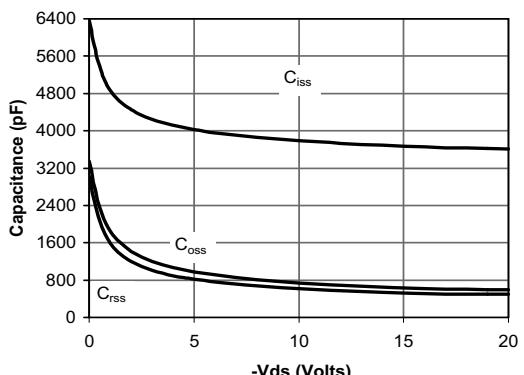


Figure 8: Capacitance Characteristics

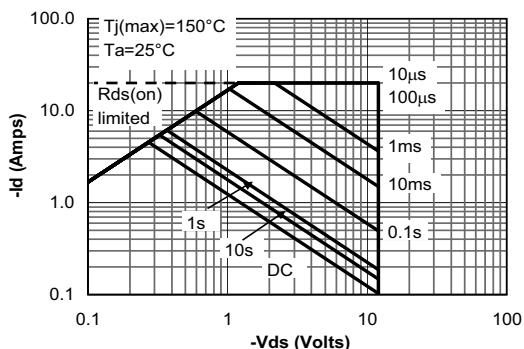


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

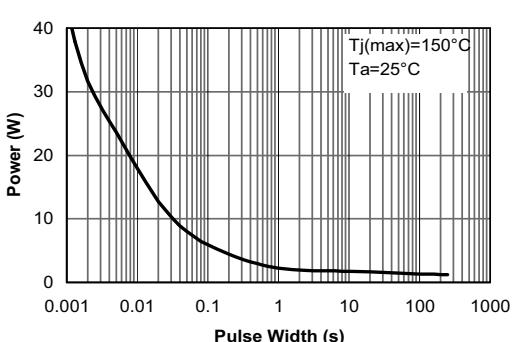


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

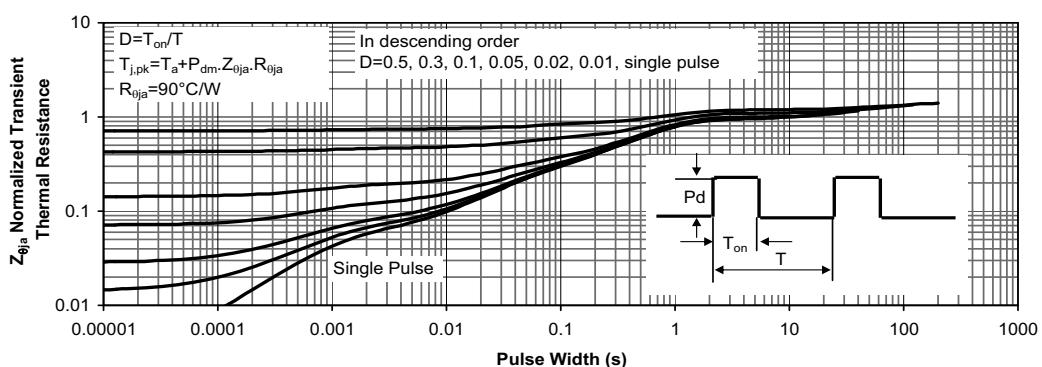


Figure 11: Normalized Maximum Transient Thermal Impedance